In the Claims:

With claims 1-35 originally pending, please cancel claims 1-3, 5 and 10-24.

Further, please amend claims 4, 6-9, 25-27 and 33, and add new claims 36-37 as

indicated in the list of pending claims to follow.

1-3. (Cancelled)

4. (Currently Amended) A The probe card assembly of claim 3 comprising a

programmable controller to control the provision of test signals to test probes of the probe

card for testing components on a wafer, wherein the programmable controller is

connected through an interface to a test system controller, where the test system

controller provides test signals to the interface to control testing of components on a

wafer, wherein the interface comprises one or more of a group consisting of a serial,

parallel, wireless, network, RF and IR interface.

5. (Cancelled)

6. (Currently Amended) A The probe card assembly of claim 1 comprising a

programmable controller to control the provision of test signals to test probes of the probe

card for testing components on a wafer, wherein the programmable controller comprises

a serial to parallel converter configured to receive the test signals, the programmable

controller configured to convert the test signals from serial to parallel and distribute the

test signals in parallel to the test probes.

-3-

Attorney Docket No.: FACT-01005US0 TAW taw/fact/1005/1005.105d.doc

P208-US

7. (Currently Amended) A The probe card assembly of claim 1 comprising a

programmable controller to control the provision of test signals to test probes of the probe

card for testing components on a wafer, wherein programmable controller is configured

to perform self testing of components included in the probe card assembly.

8. (Currently Amended) A The probe card assembly of claim 1 further comprising:

a programmable controller to control the provision of test signals to test probes of

the probe card for testing components on a wafer; and

a serial to parallel converter connected to receive signals from the programmable

controller, the serial to parallel converter being configured to convert the test signals from

serial to parallel and distribute the test signals in parallel to the test probes.

9. (Currently Amended) The A probe card assembly of claim 8, wherein the serial to

parallel converter comprises 1 further comprising: a serial digital to analog converter

connected to receive digital test signals from the programmable controller, the digital to

analog converter configured to convert the serial signals to parallel and to provide the test

signals to the test probes in analog form.

10-24. (Cancelled)

-4-

25. (Currently Amended) The probe card assembly of claim 27 24, wherein the power

supply isolation devices comprise one or more of a group consisting of voltage

regulators, switches and current limiters.

26. (Currently Amended) The probe card assembly of claim 27 24 comprising:

a space transformer supporting the test probes;

at least one daughter card; and

a base PCB electrically interconnected with the space transformer and the at least

one daughter card, wherein the power supply isolation devices are provided on at least

one of the space transformer, the base PCB, and the at least one daughter card.

27. (Currently Amended) A probe card assembly comprising:

a DC-DC converter connected between the single power supply line of a test

system controller, the power supply line distributing power through line branches to

multiple test probes, the DC-DC converter configured to increase current in a signal

provided on the power supply line; and

power supply isolation devices connected in series with the line branches, wherein

the power supply isolation devices are configured to minimize current flow on a given

one of the power supply line branches when a DUT on the given line is determined to be

faulty.

28. (Original) A probe card assembly comprising a programmable controller configured

to perform self testing of components included in the probe card assembly.

-5-

29. (Original) A probe card assembly comprising a serial interface device configured to connect to a test system controller to receive test signals for distributing to probes of the

probe card assembly.

30. (Original) The probe card assembly of claim 29, further comprising:

a serial to parallel converter for converting the test signals from serial to parallel

and distributing the test signals in parallel to a plurality of test probes.

31. (Original) The probe card assembly of claim 30, wherein the serial to parallel

converter comprises a Field Programmable Gate Array (FPGA).

32. (Original) The probe card assembly of claim 31 comprising:

a space transformer supporting the test probes;

at least one daughter card; and

a base PCB electrically interconnected with the space transformer and the at least

one daughter card, wherein the serial to parallel converter is provided on at least one of

the space transformer, the base PCB, and the at least one daughter card.

33. (Currently Amended) A probe card assembly comprising:

a serial digital to analog converter configured to serially receive digital test

signals that are to be distributed to test probes of the probe card in analog form, the

-6-

digital to analog converter configured to convert the test signals to parallel and to provide

the test signals to the test probes in analog form.

34. (Original) The probe card assembly of claim 33, further comprising:

an analog to digital converter configured to receive an analog signal from a test

device and to send a digital representation to a test system controller.

35. (Original) The probe card assembly of claim 34 comprising:

a space transformer supporting the test probes;

at least one daughter card; and

a base PCB electrically interconnected with the space transformer and the at least

one daughter card, wherein the serial digital to analog converter and the analog to digital

converter are each provided on at least one of the space transformer, the base PCB, and

the at least one daughter card.

36. (New) A probe card assembly comprising a programmable controller to control the

provision of test signals to test probes of the probe card for testing components on a

wafer, wherein the programmable controller is connected through a wireless interface to a

test system controller, where the test system controller provides test signals to the

wireless interface to control testing of components on a wafer.

37. (New) A method for testing DUTs using a probe card assembly, the probe card

assembly including a base PCB with connectors for removably connecting at least one

-7-

daughter card, the base PCB further including connectors for connecting to a test system

controller and routing lines from the connectors to contacts providing electrical

connections to test probes for contacting DUTs, the method comprising:

connecting a first one of the daughtercards to the PCB of the probe card, the first

daughtercard configured to apply signals for testing a first group of DUTs;

testing the first group of the DUTs using signals applied from the first

daughtercard through the test probes of the probe card to the first group of DUTs;

disconnecting the first daughtercard from the probe card;

connecting a second one of the daughtercards to the PCB of the probe card, the

second daughtercard configured to apply signals for testing a second group of DUTs; and

testing the second group of the DUTs using signals applied from the second

daughtercard through the test probes of the probe card to the first group of DUTs.

-8-

P208-US